



Antec Formula 6 Nano Diamond Thermal Compound

\$9.95

Product Images



Short Description

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little of the CPU's surface actually touches the heat sink, you need a solution that isolates and facilitates the transfer of heat. Formula 6's nano diamond particles minimize the distance between heat-conductive compounds and gladly take on the highest demanding CPU, optimally performing between -30°C and 250°C.

Description

A diamond-caliber solution

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Note: This Item can not be shipped using DHL

Specifications

- Diamond particles measuring 0.0000015 cm rated at 5.3 w/mK
- Extended -30°C to 250°C stable temperature range ideal for performance cooling
- Lighter, easier to spread stable composition won't crack or dry out
- Quantity: 4 g
- Specific gravity: 2.2 g/cm³

Additional Information

Brand	Antec
SKU	ANTEC-FORMULA-6
Weight	0.2500
TIM Type	Paste
Vendor SKU/EAN	761345770606

